

Issues in Shuttle System Instrumentation

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11/2/04

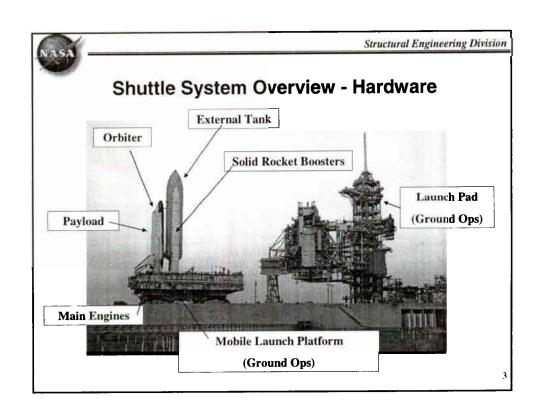
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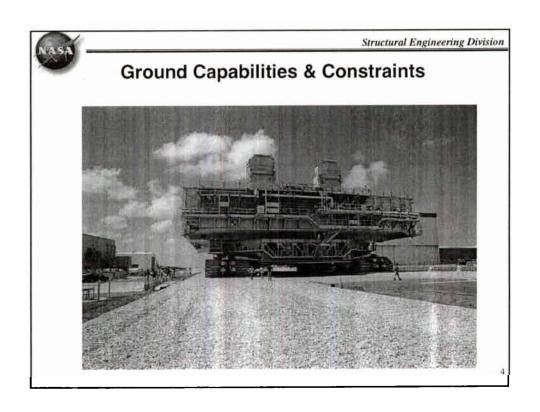


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Purpose

- 1. Customer's perspective on Space Shuttle Return-To-Flight (RTF) Instrumentation.
- 2. Focus on the difficult instrumentation issues.
- 3. Enable a discussion of new technologies (I.e. NANO/MEMS/Small Tech) that could enhance Shuttle instrumentation posture.









Ground Capabilities & Constraints

1. T 0 Umbilical

- Allows vehicle instruments to be monitored and recorded prior to launch.
- Retracts during launch.

2. Launch Complex Instrumentation

- Instruments needed for assessment of Launch Commit Criteria (LCC).
- · Salt-air and launch environments are issues.

3. Drag-On instrumentation

- Instrumentation can be added as needed to the vehicle for non-flight use.
- The current Roll-out Fatigue Testing is a primary example.



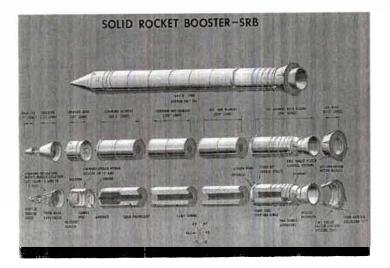
T-0 Umbilicals

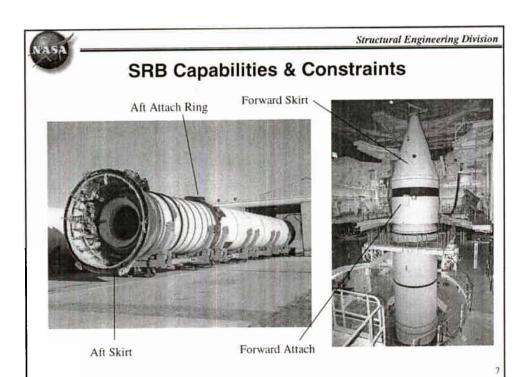
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SRB Capabilities & Constraints

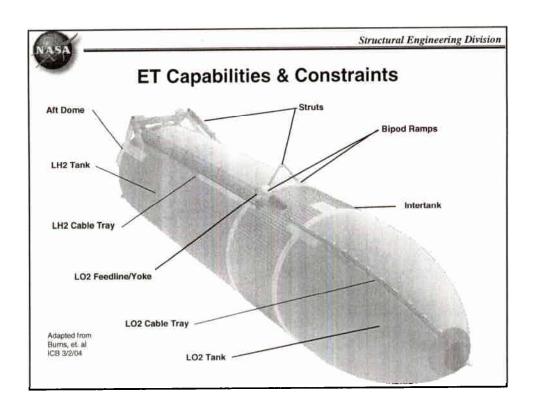






SRB Capabilities & Constraints

- 1. On-board recording is available (1st Stage Only).
 - Chamber pressures and accelerations are recorded.
 - Recording capability may be expanded.
- 2. Systems must survive difficult environments.
 - Launch acoustics, heat, overpressure.
 - Recovery water impact and immersion.
- 3. Must be electrically benign.
 - · Solid Rocket Boosters are always loaded.
 - Hydrazine powered APUs and Booster Separation Motors are also on-board.



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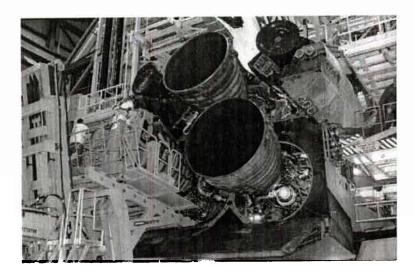
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ET Capabilities & Constraints

- 1. The system is not recovered.
 - · Historically the Orbiter has recorded the data.
 - · Telemetry is typically used now for cameras.
- 2. The environment is dangerous.
 - · Cryogenic temperatures and aerodynamic heating.
 - · Hydrogen gas is potentially present
- 3. Potential debris generation must be reduced.
 - Any external instrumentation must not become a debris source.
 - The local foam insulation must not be weakened and released.



MPS Capabilities & Constraints



11



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MPS Capabilities & Constraints

1. The engines are already instrumented.

- · The Orbiter records and transmits the data.
- · Most sensors are for engine performance.

2. The environment is dangerous.

- · Cryogenic temperatures and combustion-induced heating.
- Hydrogen and Oxygen gas are potentially present.

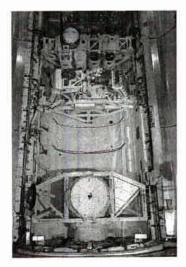
3. The environment is highly dynamic.

- · Acoustics, dynamics, and thermal shocks are all issues.
- · The resulting environment is highly complex.



Cargo Integration Capabilities & Constraints





13

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Cargo Integration Capabilities & Constraints

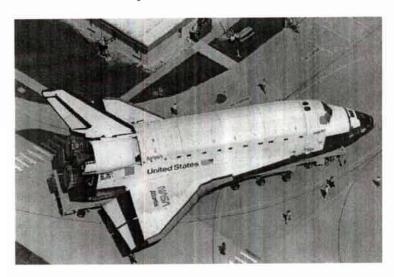
- 1. The system is always changing.
 - Payloads change from flight-to-flight and can interact significantly.
 - · The dynamic environment and response are therefore variable.
- 2. There are limited electrical feeds to cross the Orbiter interface.
 - The MADS system instruments the longeron on OV-103 & OV-102.
 - SAAMD, WB-SAAMD, Micro-TAU, and Wide-Band Micro-TAU are stand-alone units.
- 3. Time-synchronization is needed.
 - Multiple systems make this nearly-impossible today.
 - Mix of permanent and stand-alone systems.

Stand-Alone Acceleration Monitoring Device (SAAMD)





Orbiter Capabilities & Constraints



13



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Orbiter Capabilities & Constraints

- 1. The Orbiters are self-contained systems.
 - · Each vehicle has power and telemetry.
 - Each vehicle has a (Modular Auxiliary Data System) MADS recorder.
- 2. Sensors are difficult to install.
 - Tile replacement and substructure access (nose, tail) is an issue.
 - · Significant engineering support for installation, wiring, certification.
- 3. MADS System is difficult to change.
 - · Specific sensors types/sampling rates.
 - · Analog recording no on-orbit play-back





Shuttle System Overview - Orbiters

Table of MADS Channels by Orbiter

Sensor Type	Columbia OV-102	Discovery OV-103	Atlantis OV-104	Endeavor OV-105
Pressure	249	64	(2)	1
Strain	373	27	14	17
Temperature	96	5	22	9
Accel/Vib	22	54	3	18
Other	11	10	7 <u>4</u> 2	40
Total (Excluding Other)	740	150	39	45

17



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Shuttle System Overview – ET,SRB's, MLP

Instrumentation by Element

- ET None
- SRB's
 - Low Sample Rate Chamber Pressure
 - Accelerometers
- MLP 5 Microphones





Shuttle Instrumentation Issue: Number of Requested Sensors

- Original VHMS Request from Loads 881 Channels
- Original RTF Request from Loads 383 Channels
- Removing Pre-Approved Channels 230 Channels
- Program Agreed to Consider 206
- Maximum That Elements Can Support on STS-114 44
- Maximum That Elements Can Support on any of the first six missions – 178
- Possible Solution Cheap MEMS Sensors

19



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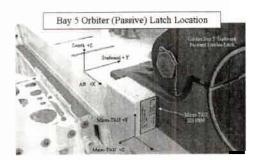
Instrumentation Issue: Manned Spaceflight Certification

- Problem Certification is costly
 - Environmental testing is required
 - Paper trail for each sensor
 - Materials must be approved
 - Batteries must be approved
 - Acceptance testing is required
 - All other safety issues must be addressed
- Possible Solution Lower the size, weight, and power



Instrumentation Issue: Integration Engineering

- Problem Integrating a sensor on the Shuttle is costly
 - Attach hardware must be designed and built
 - Wiring runs must be designed and built
 - Drawings must be produced
 - Installation must be planned in the flow
 - Maintenance must be planned and performed



Possible Solution – Small wireless systems

- Already flying wireless units on the Shuttle
- Already flying units small enough for adhesive mounting

21



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Instrumentation Issue: Large Dynamic Range Needed

- Problem The Shuttle sees a wide range of excitation
- Launch, Hi-Q, and Staging have extremely high loading
 - Input fades to a lower value before ET separation
 - Some very telling events produce minimal change in a signal
- Possible Solution MEMS-based sensors
 - MEMS-based sensors can have an extremely high dynamic range
 - Ultra-small size keeps the sensor resonances very high





Instrumentation Issue: Time Synchronization Needed

- Problem Multiple sensor systems cannot be synchronized
 - Looking for validation of system level models
 - Looking for system-level response
 - Looking for system-level anomalies
 - Looking for system-level forcing functions
 - System-level means that time synchronization is important
- Possible Solution Is there one?
 - There is no near-term solution
 - An advanced Vehicle Health Monitoring System might be capable

23



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Instrumentation Issue: Obtaining SRB Chamber Pressures

- · Problem Internal chamber pressures are difficult to obtain
 - Need chamber pressures at more than one location
 - The SRB's dominate everything during first stage flight
 - Environment is extremely harsh
 - No desire to create additional holes in case
- · Is there a solution?



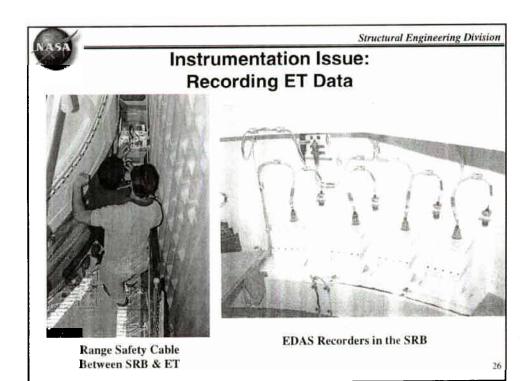


Instrumentation Issue: Recording ET Data

- Problem The ET has no data recorder
 - The ET is expendable
 - The ET has no power source
 - The ET has a couple of antenna, but they are dedicated to video
- Near Term Solution Record the data on the SRB's
 - Additional recorders can be flown on the SRB's
 - The SRB's are recovered
 - Limited data and recording time
- Long Term Solution Provide the ET a stand-alone system
 - A data system from an Atlas rocket can be used
 - Must be man-rated and certified
 - Will take up to two years to certify and implement



Atlas V





Instrumentation Issue: Internal ET Sensors Needed in Small Area

- Problem The LH2 Tank/Intertank Ring Is a Tight Fit
 - The forward Orbiter attach is on the Lowest Intertank Ring
 - This ring comes to a knife edge at the Liquid Hydrogen dome
 - An internal stiffener further crowds the area
 - Cryogenic temperatures exist
 - Acceleration, vibration
 - Sensors can be mounted before assembly if they are small enough

Knife Edge

Possible Solution:
 MEMS-size sensors

- Allows internal monitoring
- Avoids skin panel effects

27

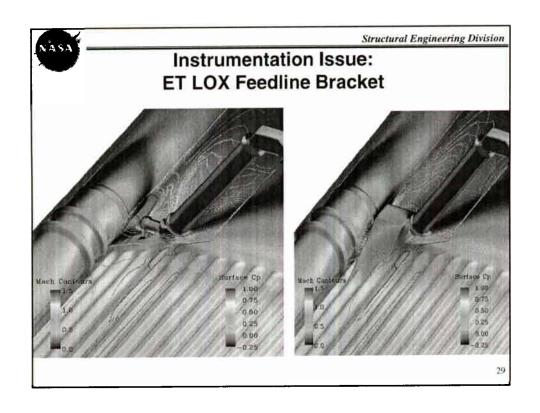
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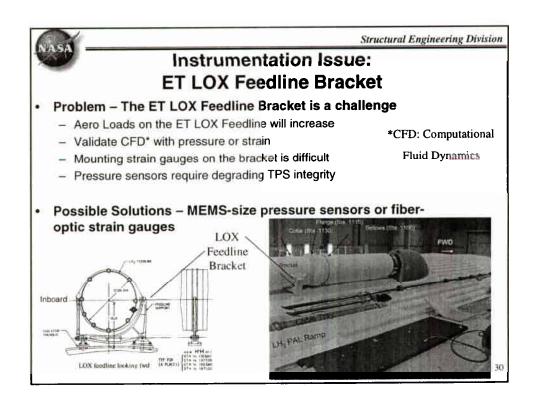
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Instrumentation Issue: External ET Sensors can be a Debris Hazard

- Problem Several ET Sensors must be mounted externally
 - Up to six ET's are covered in TPS* (Foam)
 - External sensors will require removing and replacing large sections
 - External sensors will also be a debris hazard
 - Later ET's have bare skin
 - Bare-Skin applications will see cryogenic temperatures
 - The ET experiences significant cryo-shrinkage
 - Pressure, microphone, vibration, temperature, strain
- Possible Solution MEMS-size sensors
 - Keep the size below the debris danger level
 - Smart Dust Concepts

* TPS - Thermal Protection System







Instrumentation Issue: Orbiter Wiring

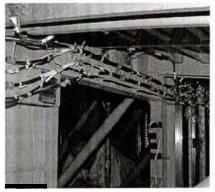
- Problem Wiring the Orbiter is difficult
 - OV-103 has some wiring in place

- OV-104 & OV-105 have little wiring in place

Wiring in OV-102 Wing Box







31



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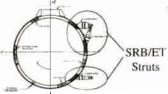
Instrumentation Issue: Strut Strain Gauge Calibration

Aft ET/Orb Struts

- Problem Strain gauges on attach struts require calibration
- SRB-ET struts can be performed by the vendor
 - SRB-ET struts do not have major TPS concerns
 - Orbiter-ET struts have to be performed on the vehicle
 - The calibration frame may be unavailable
 - TPS-covered struts are an issue



- Possible Solution Fiber Optic Sensor systems
 - May not help calibration issue
 - May help installation and recording issue









Instrumentation Issue: Orbiter TPS Change-Out

- Problem Some Sensors require special Orbiter tiles
 - Pressure, temperature, and microphones on external surfaces
 - Significant engineering and installation
- Possible Solution Small sacrificial sensors, smart dust





33



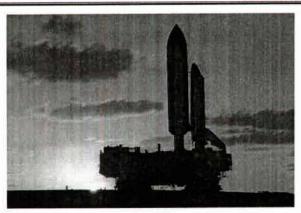
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Issues Summary

- Issues:
 - Number of Sensors
 - Certification
 - Integration Engineering
 - Dynamic Range
 - Time Synchronization
 - SRB Chamber Pressures
 - No ET Recorder
 - Internal ET Sensors in a Small Area
 - External ET Debris Hazard
 - ET LOX Feedline Bracket
 - Orbiter Wiring
 - Orbiter TPS Change-Out
 - Strut Strain Gauge Calibration







Conclusions

- 1. Instrumenting the Shuttle system will be a challenge.
- 2. New Technologies Should be considered where appropriate.
- Wireless Sensors, Smart Dust, Fiber-Optic Strain Gauges, MEMSbased sensors are possible technologies.